HD14555B, HD14556B

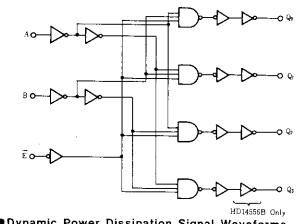
Dual Binary to 1-of-4 Decoder/Demultiplexer

The HD14555B and HD14556B decoder/demultiplexer have two select inputs (A and B), an active low Enable input (E), and four mutually exclusive outputs (Q0, Q1, Q2, Q3). The HD14555B has the selected output go to the "high" state, and the HD145556B has the selected output go to the "low" state. Expanded decoding such as binary-to-hexadecimal (1-of-16), etc., can be achieved by using other HD14555B or HD14556B devices. Applications include code conversion, address decoding, memory selection control, and demultiplexing (using the Enable input as a data input) in digital data transmission systems.

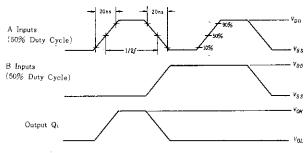
FEATURES

- Noise Immunity = 45% of V_{DD} typ. ٠
- Low Quiescent Current = 5nA/pkg typ. @5V •
- Supply Voltage Range = 3 to 18V
- All Output Buffered
- Capable of Driving One Low-power Schottky TTL Load Over the Rated Temperature Range

LOGIC DIAGRAM (1/2)

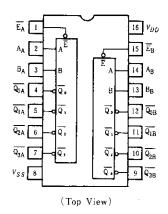


Dynamic Power Dissipation Signal Waveforms



Note) All 8 outputs connect to respective C1 loads. f in respect to a system clock.

PIN ARRANGEMENT

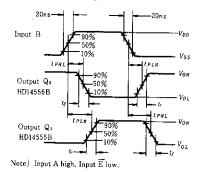


TRUTH TABLE

. In	Outputs									
Enable	Select		HD14555B				HD14556B			
Ē	В	A	Q3	Q_2	Q_1	Q,	$\overline{\mathbb{Q}_3}$	$\widetilde{\mathbf{Q}_2}$	$\overline{\mathbf{Q}_1}$	Q.,
0	0	0	0	0	0	1	1	1	1	0
0	0	1	0	0	1	0	1	1	0	1
0	1	0	0	1	0	0	1	0	1	1
0	1	1	1	0	0	0	0	1	1	1
1	×	×	0	0	0	0	1	1	1	1

× : Don't Care

Dynamic Signal Waveforms



Characteristic	Symbol	Test Conditions		-4	-40°C		25°C			85°C		
	Symbol	$V_{BB}(\mathbf{V})$	lest Conditions	min	max	min	typ	max	min	max	Unit	
Output Voltage	l.	5.0		-	0.05		0	0.05	—	0.05	v	
	Vol	10	$V_{\mu} = V_{DD}$ or 0		0.05	_	0	0.05	_	0.05		
		15			0.05	—	0	0.05	-	0.05		
		5.0		4.95	_	4.95	5.0		4.95		v	
	V_{oH}	10	$V_{in} = 0$ or V_{DD}	9.95		9.95	10	_	9.95	-		
		15		14.95	—	14.95	15		14.95	-		
Input Voltage		5.0	$V_{out} = 4.5 \text{ or } 0.5 \text{V}$		1.5	_	2.25	1.5	-	1.5		
	V_{IL}	10	$V_{out} = 9.0 \text{ or } 1.0 \text{V}$		3.0	. —	4.50	3.0	—	3.0] v	
		15	5 V _{out} =13.5 or 1.5V		4.0	-	6.75	4.0	_	4.0]	
		5.0	$V_{mi} = 0.5 \text{ or } 4.5 \text{V}$	3.5	_	3.5	2.75	_	3.5	1	v	
	V_{IR}	10	$V_{vul} = 1.0 \text{ or } 9.0 \text{V}$	7.0	_	7.0	5.50	_	7.0	_		
		15	$V_{out} = 1.5$ or $13.5V$	11.0		11.0	8.25	-	11.0	.—		
Output Drive Current		5.0	$V_{OH} = 2.5 V$	-1.0	_	-0.8	-1.7	_	-0.6	-		
	, r	5.0	$V_{GH} = 4.6V$	-0.2		-0.16	-0.36		-0.12	·	- mA	
	Гон	10	$V_{OH} = 9.5 V$	-0.5	_	-0.4	-0.9	_	-0.3			
		15	$V_{GB} = 13.5 \text{V}$	-1.4	-	-1.2	-3.5	-	-1.0	—		
		5.0	$V_{UL} = 0.4 V$	0.52	_	0.44	0.88	_	0.36		mA	
	IoL	10	$V_{0L} = 0.5V$	1.3	-	1.1	2.25	_	0.9	-		
		15	$V_{0L} = 1.5 V$	3.6	-	3.0	8.8		2.4	-		
Input Current	I,e	15			±0.3		±0.00001	±0.3	—	± 1.0	μA	
Input Capacitance	<i>C</i>		$V_{} = 0$	-			5.0	7.5	_	—	pŀ	
Quiescent Current		5.0	7 Simul		20		0.005	20	-	150) μA	
	IDD	10	Zero Signal, per Package	_	40	_	0.010	40	-	300		
		15	per rackage	—	80	-	0.015	80	_	600		
Total Supply Current*		5.0	Dynamic $+I_{DD}$,			-	0.85	—	_	-		
	Ιτ	10	per Gate	-	_	-	1.7				- μA -	
		15	$C_L = 50 \text{pF}, f = 1 \text{ kHz}$	_		_	2.6		_	—		

ELECTRICAL CHARACTERISTICS

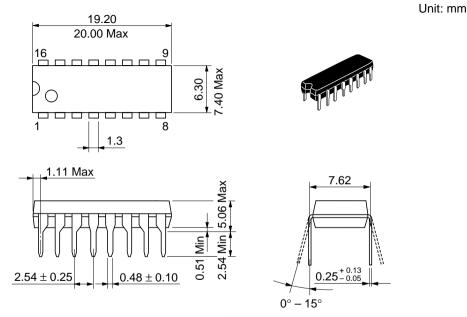
* To calculate total supply current at frequency other than 1kHz.

 $(@V_{DD}-5.0V I_T - (0.85 \mu A/kHz)f + I_{00}, (@V_{DD}=10V I_T = (1.7 \mu A/kHz)f + I_{00}, (@V_{DD}-15V I_T - (2.6 \mu A/kHz)f + I_{00}) (.6 \mu A/kHz)f$

SWITCHING CHARACTERISTICS (C_L=50pF, Ta=25°C)

Characteristi	c	Symbol	$V_{DD}(\mathbf{V})$	min	typ .	max	Unit
	t,	5.0		180	360	ns	
Output Rise Time		10		90	180		
		15	_	65	130		
	t _j	5.0	—	100	200	ns	
Output Fail Time		10		50	100		
		15		37	80		
		t _{PLH} , t _{PHL}	5.0	_	220	440	 - ns
Propagation Delay Time	A, B		10	_	95	190	
	→Q		·15	—	70	140	
			5.0		200	400	
	Ē		10		85	170]
	→Q		15	_	65	130]





Hitachi Code	DP-16
JEDEC	Conforms
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Weight (reference value)	1.07 g

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